

L Number	Hits	Search Text	DB	Time stamp
1	2460086	multilayer (substrate or board)	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 08:42
2	27600	((multilayer (substrate or board)) and (insulat\$4 adj layers))	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 09:07
3	415	((multilayer (substrate or board)) and (insulat\$4 adj layers)) and (adhesive adj layers)	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 08:43
4	127	((multilayer (substrate or board)) and (insulat\$4 adj layers)) and (adhesive adj layers)) and (cavity or opening)	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 08:44
5	71	((multilayer (substrate or board)) and (insulat\$4 adj layers)) and (adhesive adj layers)) and (cavity or opening)) and (lid or cover)	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 08:52
6	40140	((multilayer (substrate or board)) and ((insulative or insulating) and adhesive))	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 08:53
7	136	((multilayer (substrate or board)) and (insulat\$4 adj layers)) and (adhesive adj layers)) and seal\$	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/02/05 08:58
8	254	(361/795).CCLS.	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 09:05
9	34497	257/600-790.ccls. and (multilayer (substrate or board))	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 09:06
10	1263	(257/600-790.ccls. and (multilayer (substrate or board))) and lid	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 09:06
11	85	((257/600-790.ccls. and (multilayer (substrate or board))) and lid) and (insulat\$4 adj layers)	USPAT; EPO; JPO; DERWENT; USOCR	2004/02/05 09:07
12	10	("4827327" "4873566" "5307240" "5523622" "5532514" "5796165" "5874321" "5973928" "5977631" "6384479").PN.	USPAT	2004/02/05 09:07
13	4	("4320438" "4498122" "4541035" "4608592").PN.	USPAT	2004/02/05 09:10
14	59	4320438.URPN.	USPAT	2004/02/05 09:11
15	37	4827327.URPN.	USPAT	2004/02/05 09:12